


AMENDMENTS TO THE CLAIMS:

Please amend Claims 1-3, 7, 13, 14, and 18 as follows. In accordance with the revised amendment format, all claims are presented below.

1. (Currently Amended) A circuit connection structure, comprising:
-  a first substrate ~~forming~~ having a part of a display panel and an
having electrode terminals terminal formed thereon;
- a circuit board disposed with a space between said circuit board and
said substrate and having thereon an electrode terminal;
- a semiconductor device comprising a driver IC, said semiconductor
device having a first electrodes electrode and a second electrodes electrode; and with the
~~first electrodes connected to the electrode terminals of the first substrate;~~
- a flexible wiring member having disposed in a lateral position with
respect to the first substrate having thereon a pattern of conductors each extending from a
first conductor end to a second conductor end on the flexible wiring member with the first
conductor ends of the conductors a conductor, wherein opposite ends of the conductor of
said flexible wiring member are connected to the second ~~electrodes of the semiconductor~~
~~device, and a circuit board disposed with a space from the first substrate and having~~
~~thereon electrode terminals connected to the second conductor ends of the conductors on~~
~~the flexible wiring member~~ electrode and the electrode terminal of said circuit board,
respectively, and

wherein said semiconductor device bridges the space between the first substrate and the circuit board; and such that the driver IC is located over the space and the first electrode of the semiconductor device is connected ~~the second conductor ends of the conductors on the flexible wiring member are connected to the electrode terminals of the circuit board, and the first electrodes of the semiconductor device are connected to the electrode terminals of~~ terminal on the first substrate, respectively; with an anisotropic conductive adhesive.

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2. (Currently Amended) A connection structure according to Claim 1, wherein in said semiconductor device the first and second electrodes are structured to act as output and input electrodes, respectively, thereof so as to receive input data from the circuit board and supply output signals to the first substrate, thereby driving an electronic device including the first substrate.

3. (Currently Amended) A connection structure according to Claim 1, wherein the second ~~electrodes~~ electrode of the semiconductor device ~~are~~ is connected to the ~~first conductor ends of the conductors~~ conductor on the flexible wiring member by a tape-automated bonding method.

4-6 (Cancelled)

7. (Currently Amended) A connection structure according to Claim 1, wherein ~~a connecting part~~ the connection between the second ~~electrodes~~ electrode of the semiconductor device and the ~~first conductor ends of the conductors~~ conductor on the flexible wiring member is sealed with a resin.

8. (Withdrawn)

9. (Withdrawn)

10-12 (Cancelled)

13. (Currently Amended) A display apparatus, comprising:

a display panel comprising at least one substrate, said at least one substrate having thereon a pixel ~~electrodes~~ electrode extending to form an electrode ~~terminals~~ terminal on a peripheral side of ~~the~~ said at least one substrate;

a semiconductor device having an input ~~electrodes~~ electrode, and an output ~~electrodes~~ electrode for supplying drive waveforms to the pixel ~~electrodes~~ electrode of the display panel; and

a circuit board disposed with a space ~~from the display panel~~ between said circuit board and said at least one substrate of the display panel and having an electrode ~~terminals~~ terminal for supplying an electric power and control signals to the semiconductor device; ~~wherein~~

~~the electrode terminals on at least one substrate of the display panel are connected to the output electrodes of the semiconductor device, and~~

wherein the semiconductor device is connected to the circuit board via a flexible wiring member disposed in a lateral position with respect to the said at least one substrate, said flexible wiring member having thereon a pattern of conductors conductor ~~each~~ extending from a first conductor end to a second conductor end so that the input ~~electrodes~~ electrode of the semiconductor device ~~are~~ is connected to the first conductor ~~ends of the conductors on the flexible wiring member~~ end, and the second conductor ~~ends of the conductors of the flexible wiring member are~~ end is connected to the electrode ~~terminals~~ terminal of the circuit board, and

wherein said semiconductor device bridges the space between said at least one substrate of the display panel and the circuit board, and the second conductor ends of the conductors on the flexible wiring member are connected to the electrode terminals of the circuit board, and such that the driver IC is located over the space and the output electrodes electrode of the semiconductor device ~~are~~ is connected to the electrode ~~terminals~~ terminal on said at least one substrate of the display panel, ~~respectively,~~ with an anisotropic conductive adhesive.

14. (Currently Amended) A display apparatus according to Claim 13, wherein the input ~~electrodes~~ electrode of the semiconductor device ~~are~~ is connected to the first conductor ~~ends~~ end of the ~~conductors~~ conductor on the flexible wiring member by a tape-automated bonding method.

15. (Cancelled)

16. (Withdrawn)

17. (Cancelled)

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18. (Currently Amended) A display apparatus according to Claim 13,
wherein ~~a connecting part~~ the connection between the second ~~electrodes~~ electrode of the
semiconductor device and the first conductor ~~ends~~ end of the ~~conductors~~ conductor on the
flexible wiring member is sealed with a resin.

19-29 (Withdrawn)
